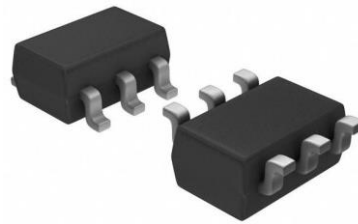


WNMD2176
Dual N-Channel, 20V, 2.6A, Power MOSFET
www.sh-willsemi.com

| V_{DS} (V) | Typical $R_{DS(on)}$ (m Ω) |
|---------------|------------------------------------|
| 20 | 56@ $V_{GS}=4.5V$ |
| | 76@ $V_{GS}=2.5V$ |
| ESD Protected | |


Descriptions

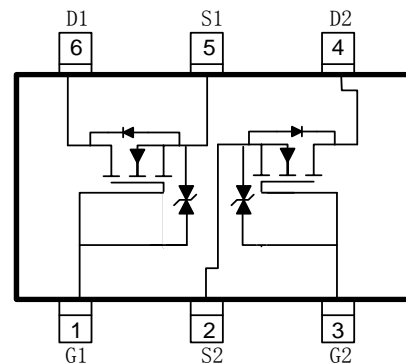
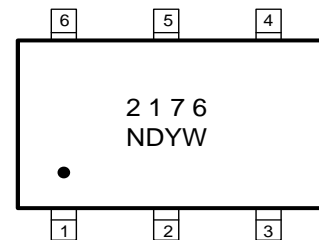
The WNMD2176 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WNMD2176 is Pb-free.

Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package SOT-23-6L

Applications

- Driver for Relay, Solenoid, Motor, LED etc.
- Power supply converters circuit
- Load/Power Switching for portable device

SOT-23-6L

Pin configuration (Top view)


2176 = Device Code
 ND = Special Code
 Y = Year
 W = Week(A~z)

Marking
Order information

| Device | Package | Shipping |
|---------------|-----------|----------------|
| WNMD2176-6/TR | SOT-23-6L | 3000/Tape&Reel |

Absolute Maximum ratings

| Parameter | Symbol | 10 s | Steady State | Unit | |
|--|-----------|------------------------|--------------|------------------|---|
| Drain-Source Voltage | V_{DS} | 20 | | V | |
| Gate-Source Voltage | V_{GS} | ± 10 | | | |
| Continuous Drain Current ^a | I_D | $T_A=25^\circ\text{C}$ | 2.8 | 2.6 | A |
| | | $T_A=70^\circ\text{C}$ | 2.3 | 2.1 | |
| Maximum Power Dissipation ^a | P_D | $T_A=25^\circ\text{C}$ | 1.1 | 0.9 | W |
| | | $T_A=70^\circ\text{C}$ | 0.7 | 0.6 | |
| Continuous Drain Current ^b | I_D | $T_A=25^\circ\text{C}$ | 2.6 | 2.3 | A |
| | | $T_A=70^\circ\text{C}$ | 2.0 | 1.9 | |
| Maximum Power Dissipation ^b | P_D | $T_A=25^\circ\text{C}$ | 0.9 | 0.7 | W |
| | | $T_A=70^\circ\text{C}$ | 0.5 | 0.4 | |
| Pulsed Drain Current ^c | I_{DM} | 7 | | A | |
| Operating Junction Temperature | T_J | 150 | | $^\circ\text{C}$ | |
| Lead Temperature | T_L | 260 | | $^\circ\text{C}$ | |
| Storage Temperature Range | T_{stg} | -55 to 150 | | $^\circ\text{C}$ | |

Thermal resistance ratings

| Single Operation | | | | | |
|---|-----------------------|-----------------|---------|---------|--------------------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Junction-to-Ambient Thermal Resistance ^a | $t \leq 10 \text{ s}$ | $R_{\theta JA}$ | 90 | 108 | $^\circ\text{C/W}$ |
| | Steady State | | 110 | 130 | |
| Junction-to-Ambient Thermal Resistance ^b | $t \leq 10 \text{ s}$ | $R_{\theta JA}$ | 105 | 128 | |
| | Steady State | | 133 | 158 | |
| Junction-to-Case Thermal Resistance | Steady State | $R_{\theta JC}$ | 60 | 75 | |

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

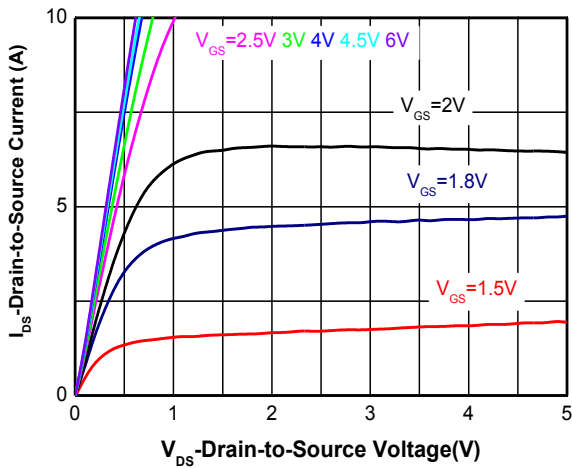
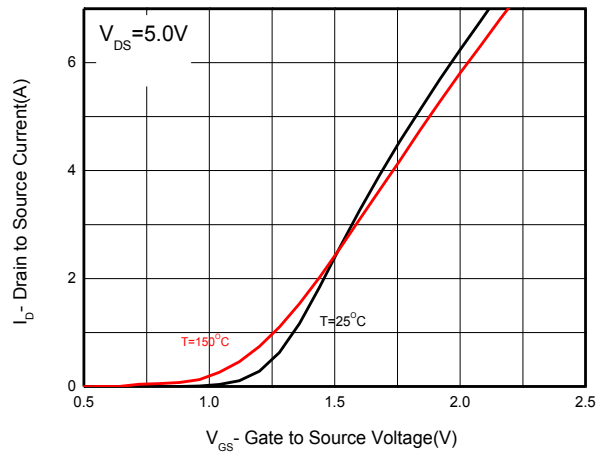
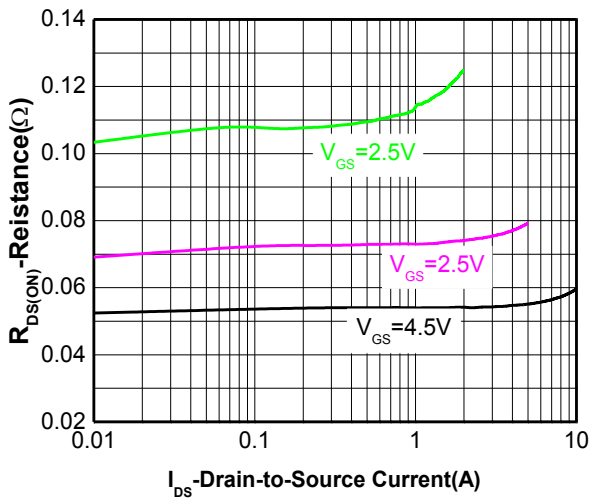
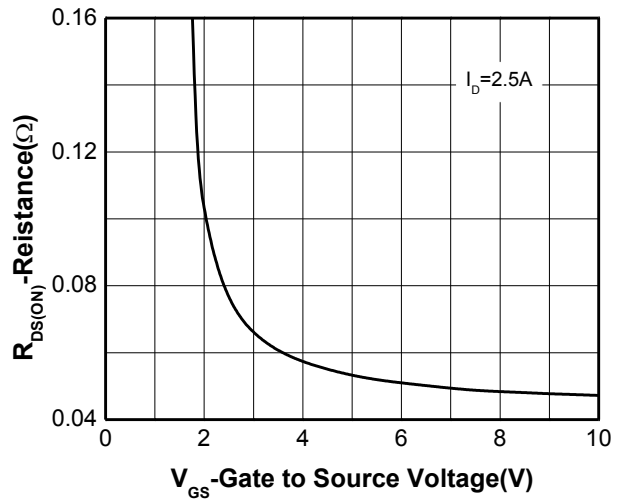
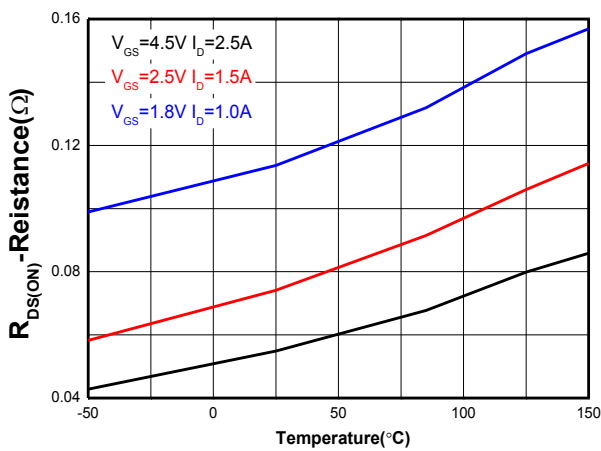
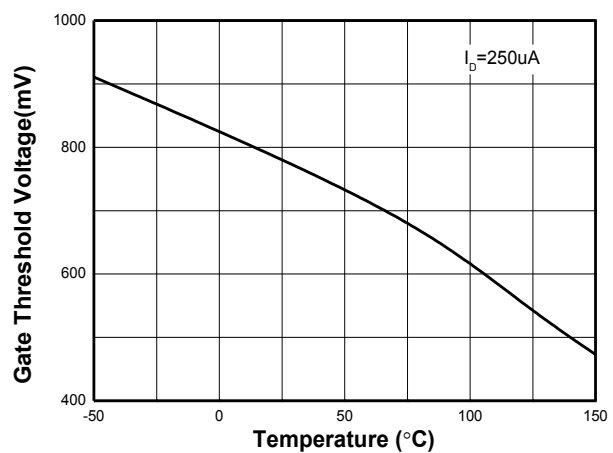
b Surface mounted on FR4 board using minimum pad size, 1oz copper

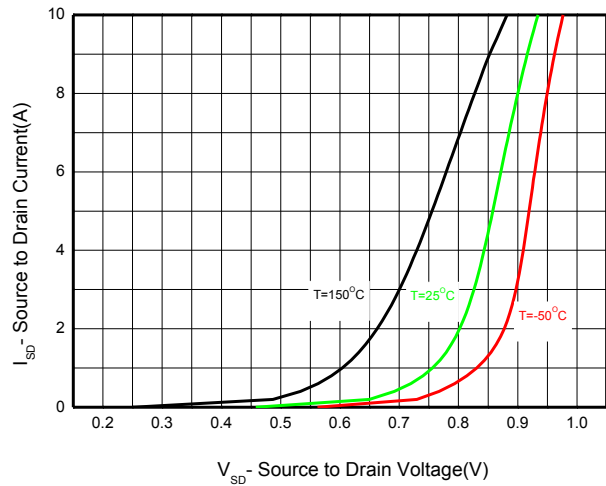
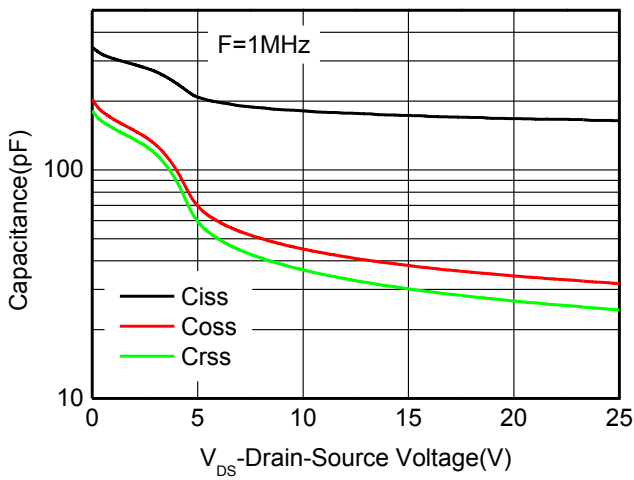
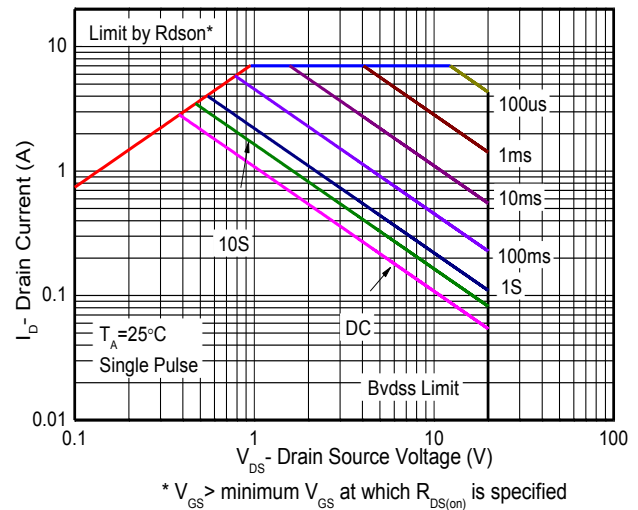
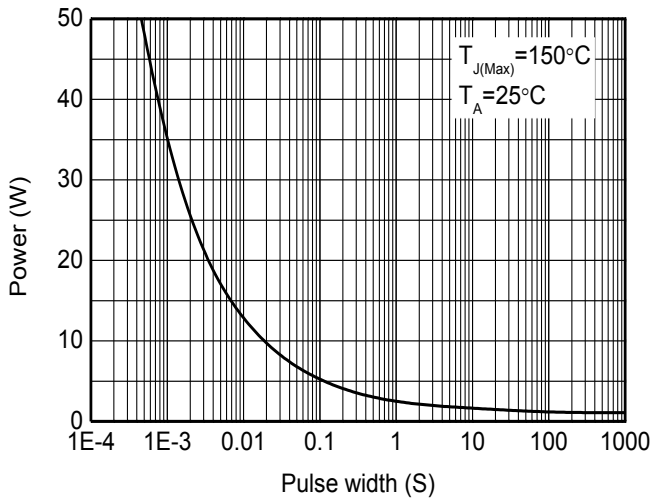
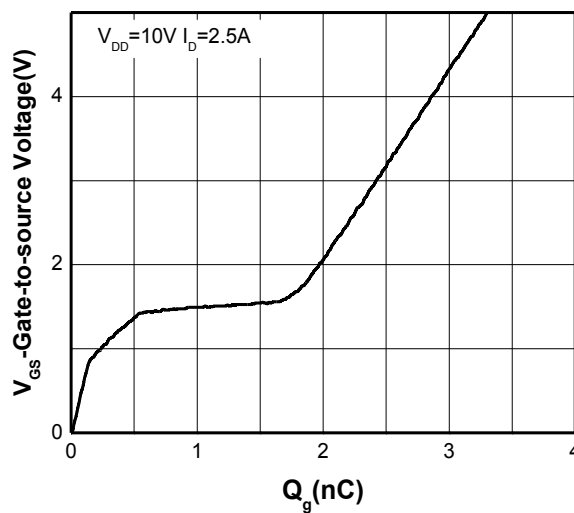
c Repetitive rating, pulse width limited by junction temperature, $t_p=10\mu\text{s}$, Duty Cycle=1%

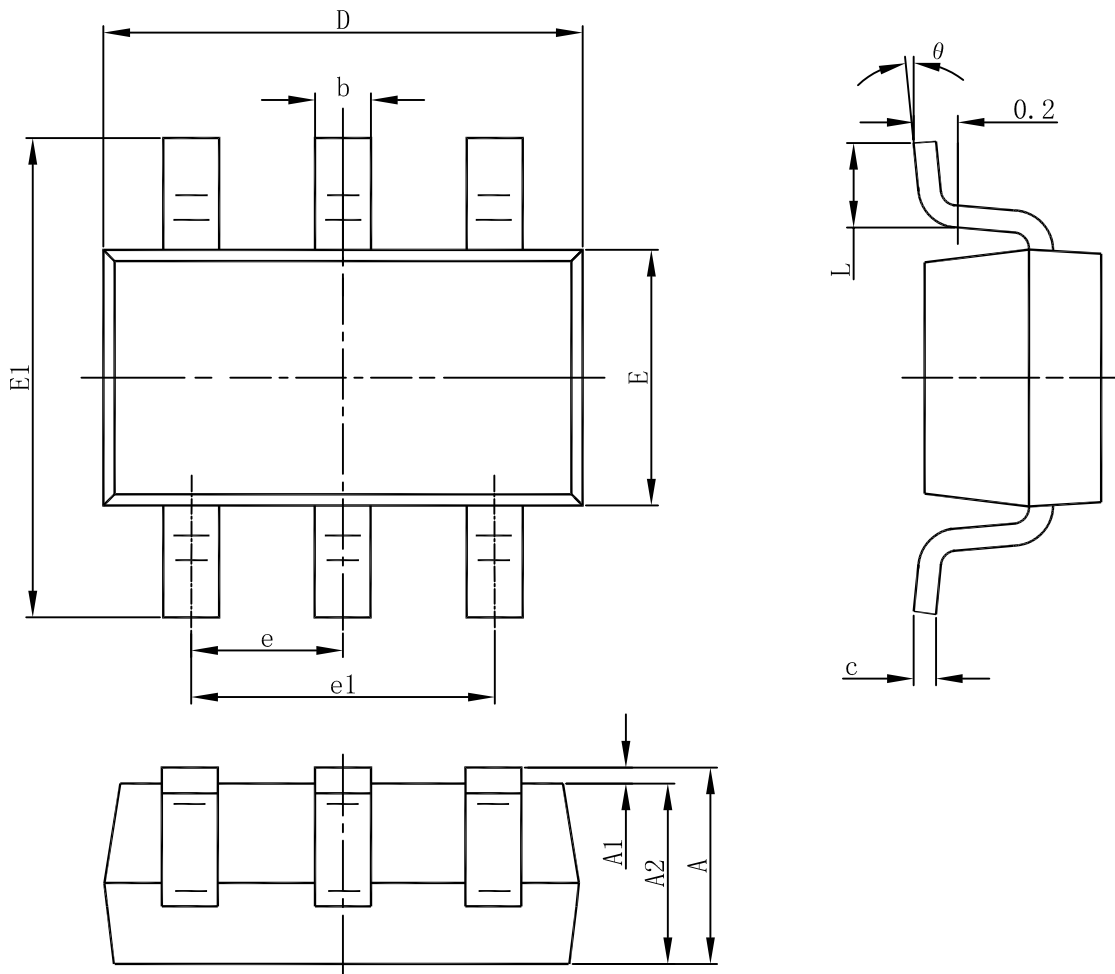
d Repetitive rating, pulse width limited by junction temperature $T_J=150^\circ\text{C}$.

Electronics Characteristics (Ta=25°C, unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|--------------|--|------|------|---------|---------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-to-Source Breakdown Voltage | BV_{DSS} | $V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}$ | 20.5 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 16\text{ V}, V_{GS} = 0\text{ V}$ | | | 100 | nA |
| Gate-to-source Leakage Current | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 10\text{ V}$ | | | ± 5 | μA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | $V_{GS} = V_{DS}, I_D = 250\mu\text{A}$ | 0.5 | 0.78 | 1.0 | V |
| Drain-to-source On-resistance | $R_{DS(on)}$ | $V_{GS} = 4.5\text{ V}, I_D = 2.5\text{ A}$ | 40 | 55 | 90 | m Ω |
| | | $V_{GS} = 3.1\text{ V}, I_D = 2.0\text{ A}$ | 45 | 66 | 110 | |
| | | $V_{GS} = 2.5\text{ V}, I_D = 1.5\text{ A}$ | 51 | 75 | 130 | |
| Forward Transconductance | g_{FS} | $V_{DS} = 5.0\text{ V}, I_D = 7.0\text{ A}$ | | 11 | 16 | S |
| CHARGES, CAPACITANCES AND GATE RESISTANCE | | | | | | |
| Input Capacitance | C_{ISS} | $V_{GS} = 0\text{ V}, f = 1\text{ MHz}, V_{DS} = 10\text{ V}$ | | 190 | | pF |
| Output Capacitance | C_{OSS} | | | 45 | | |
| Reverse Transfer Capacitance | C_{RSS} | | | 36 | | |
| Total Gate Charge | $Q_{G(TOT)}$ | $V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V}, I_D = 2.5\text{ A}$ | | 3.1 | | nC |
| Threshold Gate Charge | $Q_{G(TH)}$ | | | 0.1 | | |
| Gate-to-Source Charge | Q_{GS} | | | 0.55 | | |
| Gate-to-Drain Charge | Q_{GD} | | | 1.1 | | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | $t_d(ON)$ | $V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V}, R_L = 10\Omega, R_G = 6\Omega$ | | 12.2 | | ns |
| Rise Time | t_r | | | 12.5 | | |
| Turn-Off Delay Time | $t_d(OFF)$ | | | 29.6 | | |
| Fall Time | t_f | | | 9.8 | | |
| BODY DIODE CHARACTERISTICS | | | | | | |
| Forward Voltage | V_{SD} | $V_{GS} = 0\text{ V}, I_S = 1.0\text{ A}$ | | | 1.5 | V |

Typical Characteristics (Ta=25°C, unless otherwise noted)

Output characteristics

Transfer characteristics

On-Resistance vs. Drain current

On-Resistance vs. Gate-to-Source voltage

On-Resistance vs. Junction temperature

Threshold voltage vs. Temperature


Capacitance
Body diode forward voltage

Single pulse power
Safe operating power

Transient thermal response (Junction-to-Ambient)

Package outline dimensions
SOT-23-6L


| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950(BSC) | | 0.037(BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| θ | 0° | 8° | 0° | 8° |